

**General Description**

The SJH085ND10 uses SGT technology to provide excellent  $R_{DS(ON)}$ , low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

**Features**

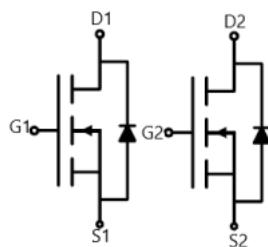
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

**Application**

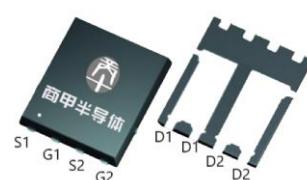
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

**Key Performance Parametes**

Parameter	Value	Unit
$V_{DS}$	100	V
$R_{DS(ON)}_{TYP}$	9.3	mΩ
$I_D$	61	A
$Q_G$	26	nC



Schematic Diagram



PDFN5X6-8L top&amp;bottom view

**Package Marking and Ordering Information**

Device/Ordering Code	Marking	Package	Reel Size	Tape width	Quantity
SJH085ND10	SJH085ND10	PDFN5X6	\	\	\

**Table 1. Absolute Maximum Ratings ( $T_c=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	100	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_c=25^\circ\text{C}$ )	61	A
	Drain Current-Continuous( $T_c=100^\circ\text{C}$ )	39	A
$I_{DM}$ (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	244	A
$P_D$	Maximum Power Dissipation( $T_c=25^\circ\text{C}$ )	73	W
	Maximum Power Dissipation( $T_c=100^\circ\text{C}$ )	29	W
$E_{AS}$	Avalanche energy (Note 2)	196	mJ
$T_J$ , $T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	°C

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{JC}$	Thermal Resistance, Junction-to-Case		1.7	°C/W



## 100V N-Channel SGT Power MOSFET

Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	100			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=100\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			1	$\mu\text{A}$
		$V_{\text{DS}}=100\text{V}$ , $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			100	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=250\mu\text{A}$	1		2.5	V
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$		26.4		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=20\text{A}$ $T_J=25^\circ\text{C}$		9.3	11.6	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=4.5\text{V}$ , $I_{\text{D}}=20\text{A}$ $T_J=25^\circ\text{C}$		11.7	15.2	$\text{m}\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=50\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1.0\text{MHz}$		1406		pF
$C_{\text{oss}}$	Output Capacitance			494		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			16.4		pF
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $f=1.0\text{MHz}$		1.12		$\Omega$
<b>Switching Parameters</b>						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=50\text{V}$ , $R_L=2.5\Omega$ , $R_{\text{GEN}}=6\Omega$		7.5		nS
$t_r$	Turn-on Rise Time			15.8		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			31		nS
$t_f$	Turn-Off Fall Time			28		nS
$Q_g$	Total Gate Charge	$V_{\text{GS}}=10\text{V}$ , $V_{\text{DS}}=50\text{V}$ , $I_{\text{D}}=20\text{A}$		26		nC
$Q_{\text{gs}}$	Gate-Source Charge			4.3		nC
$Q_{\text{gd}}$	Gate-Drain Charge			6.7		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{\text{SD}}$	Source-Drain Current (Body Diode)				61	A
$V_{\text{SD}}$	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=20\text{A}$			1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=20\text{A}$ , $dI/dt=100\text{A/S}$		43		ns
$Q_{\text{rr}}$	Reverse Recovery Charge	$I_F=20\text{A}$ , $dI/dt=100\text{A/S}$		35		nC

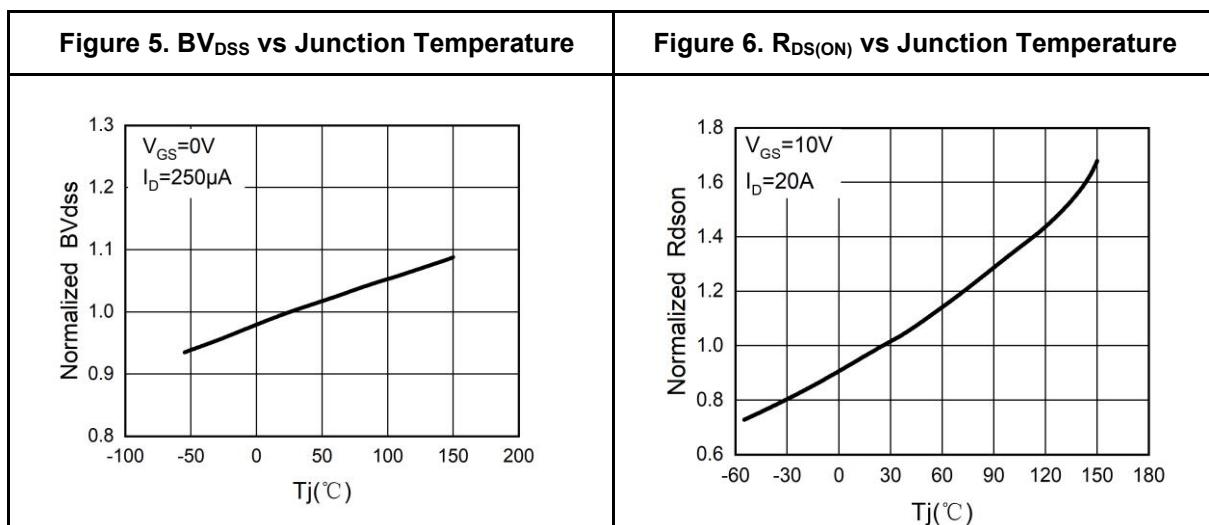
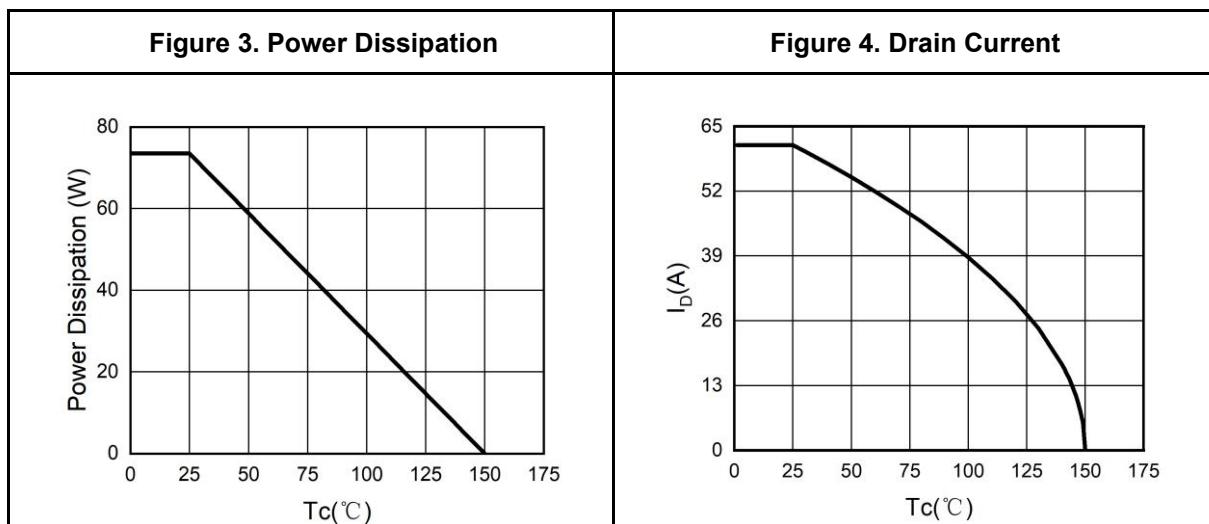
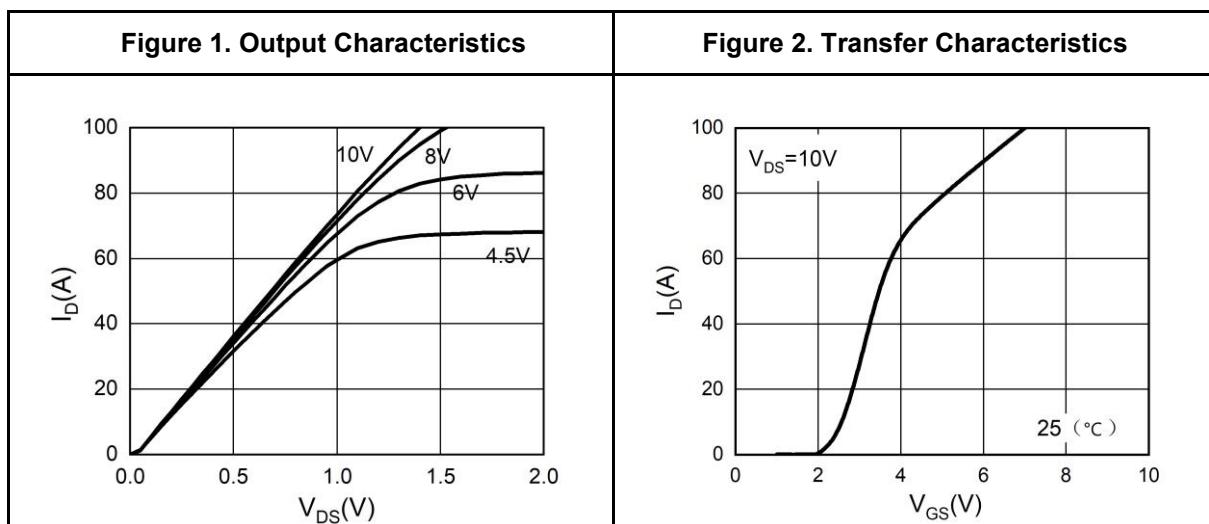
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E<sub>AS</sub> condition:  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=40\text{V}$ ,  $V_G=10\text{V}$ ,  $R_g=25\Omega$ ,  $L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

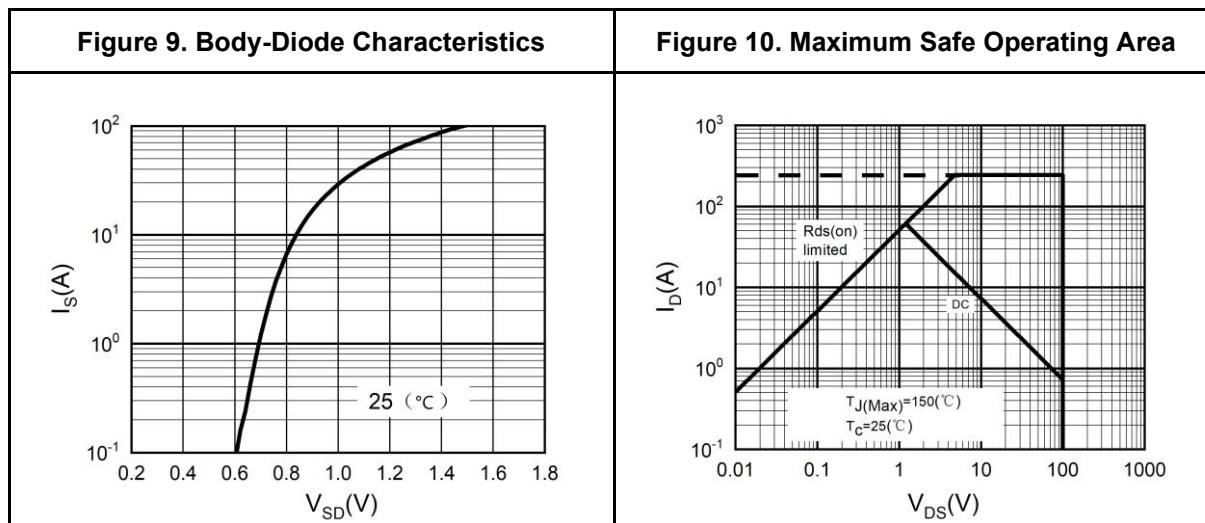
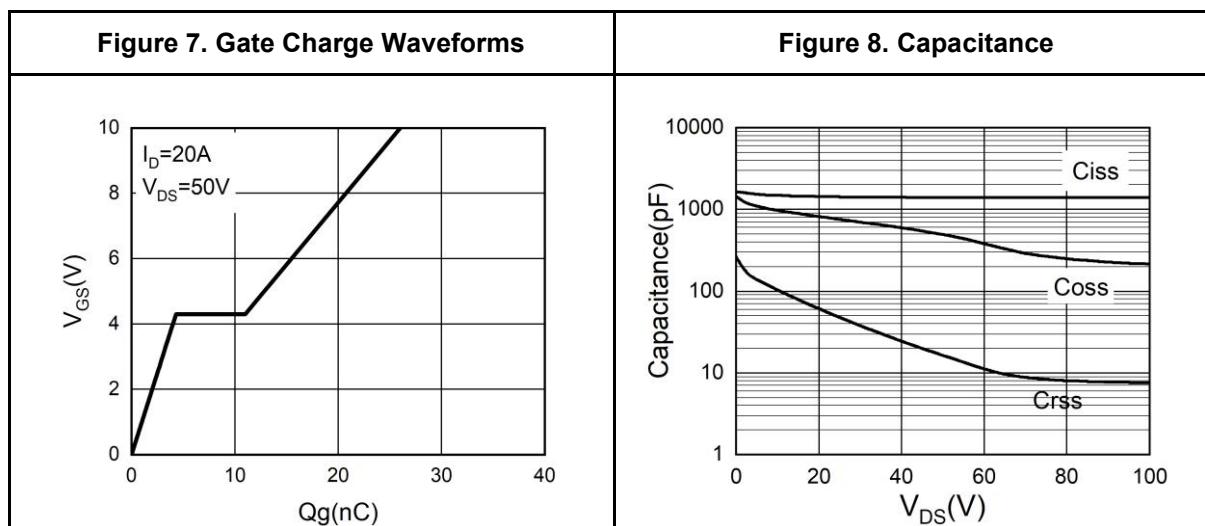


## Typical Electrical And Thermal Characteristics (Curves)



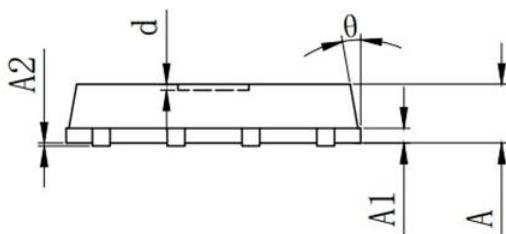
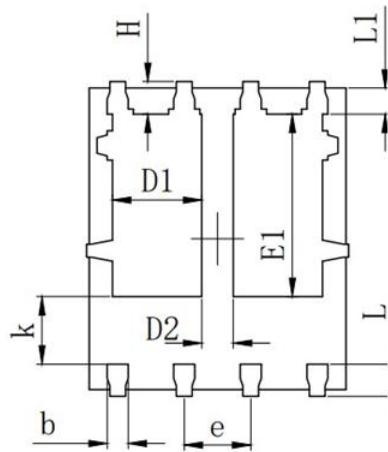
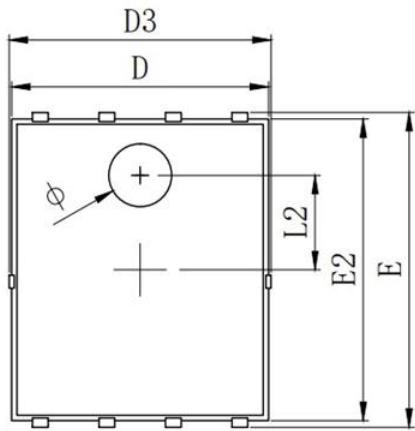


## Typical Electrical And Thermal Characteristics (Curves)





## PDFN5X6-8L Package Information



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	0.900	1.000	1.100
A1	0.254	REF.	
A2	0~0.05		
D	4.824	4.900	4.976
D1	1.605	1.705	1.805
D2	0.500	0.600	0.700
D3	4.924	5.000	5.076
E	5.924	6.000	6.076
E1	3.375	3.475	3.575
E2	5.674	5.750	5.826
b	0.350	0.400	0.450
e	1.270	TYP.	
L	0.534	0.610	0.686
L1	0.424	0.500	0.576
L2	1.800	REF.	
k	1.190	1.290	1.390
H	0.549	0.625	0.701
θ	8°	10°	12°
ϕ	1.100	1.200	1.300
d			0.100



## Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

The performances and characteristics of this product in the independent testing state are displayed in this document. Wuxi Shangjia Semiconductor can't guarantee of the performances and characteristics of this described product that mounted in the customer's products or equipments as same as that in the independent testing state. So the customer should evaluate and test devices mounted in the customer's products or equipments.

Wuxi Shangjia Semiconductor reserves the right to improve the designs, functions and reliability of this product and modify any and all information described in this document without notice customer, apart from that when an notice agreement is signed between customer and Wuxi Shangjia Semiconductor.

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Wuxi Shangjia Semiconductor hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.